# 1-2013325-4 ACTIVE

### Dynamic Series | Dynamic 1000 Series

TE Internal #: 1-2013325-4

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.5 mm [. 137 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

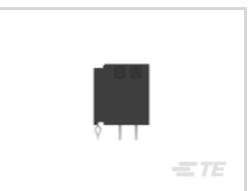
Dynamic 1000 Series

View on TE.com >

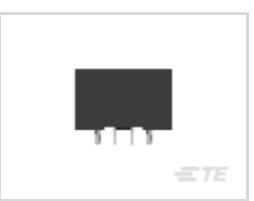


Connectors > PCB Connectors > PCB Headers & Receptacles > DYNAMIC 1900D HDR ASSY











Connector System: Wire-to-Board

Number of Positions: 8
Number of Rows: 2

Centerline (Pitch): 3.5 mm [ .137 in ]
PCB Mount Orientation: Vertical

All DYNAMIC 1900D HDR ASSY (9)

### **Features**

#### **Product Type Features**

rioduct Type reatures	
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	8
Number of Rows	2
PCB Mount Orientation	Vertical
Body Features	
Primary Product Color	Black



Contact Mating Area Plating Material Thickness	.38 μm[15 μin]
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	4 A
Termination Features	
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Keyed
Mating Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With
Housing Features	
Housing Material	Nylon 66 GF
Centerline (Pitch)	3.5 mm[.137 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	

## **Product Compliance**

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	

Tube



Current ECHA Candidate List: JUNE 2024

(241)

Candidate List Declared Against: JUNE

2024 (241)

Does not contain REACH SVHC

Halogen Content

Not Low Halogen - contains Br or Cl > 900
ppm.

Solder Process Capability Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

### Compatible Parts



# Also in the Series | Dynamic 1000 Series



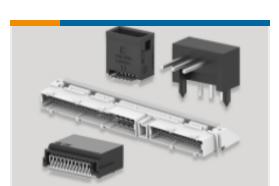
Connector Contacts(40)



Connector Hardware(3)

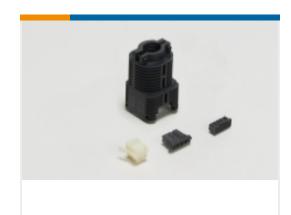


Insertion & Extraction Tools(2)



PCB Headers & Receptacles(173)

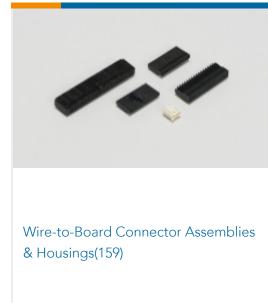








Standard Rectangular Connectors(4)



# Customers Also Bought





### **Documents**

### **Product Drawings**

DYNAMIC 1900D HDR ASSY V-TYPE 8P

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1-2013325-4\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-2013325-4\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1-2013325-4\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the  $\pmb{\mathsf{Terms}}$  and  $\pmb{\mathsf{Conditions}}$  of use.

### Datasheets & Catalog Pages

**DYNAMIC SPRING CLAMP SERIES** 

English

**DYNAMIC SPRING CLAMP SERIES** 

Japanese

1-1773721-5\_DYNAMIC\_SERIES\_QRG

English

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 3.5 mm [.137 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 1000 Series



**Product Specifications** 

**Product Specification** 

Japanese